

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of Applicants:

Beaman et al.

Serial No.: 09/382,834

Filed: August 25, 1999

For: HIGH DENSITY INTEGRATED CIRCUIT APPARATUS, TEST PROBE AND
METHODS OF USE THEREOF

Date: July 30, 2008

Group Art Unit: 2829

Examiner: V. P. Nguyen

Docket No.: YOR919930028US5

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

SUBMISSION OF FORMAL DRAWINGS

Sir:

Enclosed herewith are twelve (12) sheets of formal drawings (FIGS. 17-39) replacing the previously added informal drawings submitted with the Amendment of June 16, 2005, for the above-identified application.

Please charge any fee necessary to enter this paper and any previous paper to deposit account 09-0468.

Respectfully submitted,

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